
**Information technology — UPnP
Device Architecture —**

**Part 26-2:
Telephony device control protocol —
Level 2 — Telephony client device**

Technologies de l'information — Architecture de dispositif UPnP —

*Partie 26-2: Protocole de contrôle de dispositif de téléphonie —
Niveau 2 — Dispositif de client de téléphonie*





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The list of all currently available parts of ISO/IEC 29341 series, under the general title *Information technology — UPnP Device Architecture*, can be found on the [ISO web site](#).

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